# MA3X028 Series (MA28 Series)

## Silicon epitaxial planar type

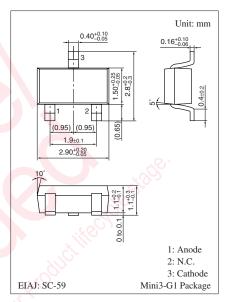
For reduced voltage and temperature compensation

#### ■ Features

- Extremely small reverse current I<sub>R</sub>
- High reliability with planar structure
- Wide forward voltage V<sub>F</sub> range

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage		$V_R$	6	V
Peak forward	MA3X0280A/B	$I_{FM}$	150	mA
current	MA3X028WA/WB		100	
	MA3X028TA/TB		70	
Power dissipation		$P_{\mathrm{D}}$	150	mW
Junction temperature		Tj	125	°C
Storage temperature		T <sub>stg</sub>	-55 to +125	°C



## Marking Symbol

MA3X0280A : MD
 MA3X0280B : ME
 MA3X028WA : MF
 MA3X028WB : MK
 MA3X028TA : ML
 MA3X028TB : MM

## ■ Electrical Characteristics T<sub>a</sub> = 25°C ± 3°C \*1

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	MA3X028WA/WB	$V_{F1}$	$I_F = 10 \mu A$	0.77	35		V
	MA3X028TA/TB	~0),		1.15			
Forward voltage	MA3X0280A	$V_{F2}$	I <sub>F</sub> = 1.5 mA	0.56		0.61	V
	MA3X0280B		will sails	0.59		0.64	
	MA3X028WA		$I_F = 3 \text{ mA}$	1.18		1.28	
	MA3X028WB			1.26		1.36	
	MA3X028TA			1.76		1.92	
	MA3X028TB			1.88		2.04	
Reverse current		$I_R$	$V_R = 6 \text{ V}$			1.0	μΑ
Temperature coefficient of	MA3X0280A/B	$-\Delta V_F/\Delta T$	$I_F = 3 \text{ mA}$		2.0		mV/°C
	MA3X028WA/B				4.6		
forward voltage *2	MA3X028TA/B				6.5		

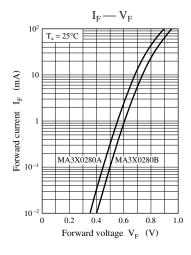
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

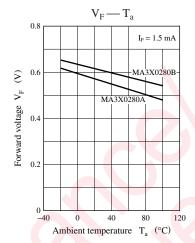
- 2. Absolute frequency of input and output is 100 MHz
- 3. \*1: The temperature must be controlled 25°C for  $V_F$  measurement.  $V_F$  value measured at other temprature must be adjusted to  $V_F$  (25°C).

\*2:  $T_i = 25^{\circ}C$  to  $150^{\circ}C$ 

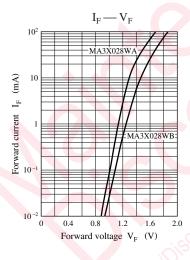
Note) The part numbers in the parenthesis show conventional part number.

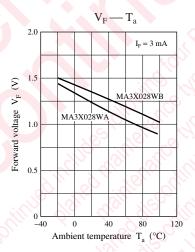
#### Characteristics charts of MA3X028



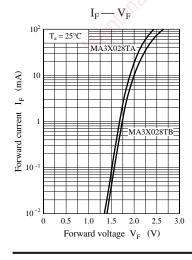


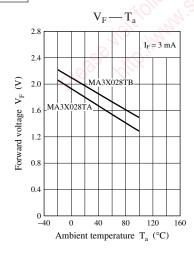
## Characteristics charts of MA3X028W





### Characteristics charts of MA3X028T





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